EC Declaration of Conformity (DoC)

We

Texas Instruments Incorporated
12500 TI Boulevard
Dallas, Texas 75243 USA

Declare that the DoC is issued under our sole responsibility and belongs to the following product(s):

<table>
<thead>
<tr>
<th>Marketing Name:</th>
<th>WL18xxMOD WiLink™ 8 Single-Band Combo Module – Wi-Fi®, Bluetooth® and Bluetooth Low Energy (LE)</th>
</tr>
</thead>
<tbody>
<tr>
<td>Equipment Name:</td>
<td>Wi-Fi and Bluetooth Module</td>
</tr>
<tr>
<td>Model Number:</td>
<td>WL18MODGB (Test Grade 31: WL1831MODGBMOC)</td>
</tr>
<tr>
<td>SW Version:</td>
<td>R8.7.SP2</td>
</tr>
</tbody>
</table>

The object of the declaration described above is in conformity with the relevant Union harmonization legislation:

RoHS2 Directive 2011/65/EU

Accessories information:

Antennas

<table>
<thead>
<tr>
<th></th>
<th>Brand</th>
<th>Antenna Type</th>
<th>Model</th>
<th>2.4GHz ~ 2.5GHz Gain</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>Ethertronics</td>
<td>PCB</td>
<td>1000423</td>
<td>-0.6dBi</td>
</tr>
<tr>
<td>2</td>
<td>LSR</td>
<td>Rubber Whip / Dipole</td>
<td>001-0012</td>
<td>2dBi</td>
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<tr>
<td>3</td>
<td></td>
<td></td>
<td>080-0013</td>
<td>2dBi</td>
</tr>
<tr>
<td>4</td>
<td></td>
<td></td>
<td>080-0014</td>
<td>2dBi</td>
</tr>
<tr>
<td>5</td>
<td></td>
<td>PIFA</td>
<td>001-0016</td>
<td>2.5dBi</td>
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<tr>
<td>6</td>
<td></td>
<td></td>
<td>001-0021</td>
<td>2.5dBi</td>
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<tr>
<td>7</td>
<td>Laird</td>
<td>PCB</td>
<td>CAF94504</td>
<td>2dBi</td>
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<tr>
<td>8</td>
<td></td>
<td></td>
<td>CAF94505</td>
<td>2dBi</td>
</tr>
<tr>
<td>9</td>
<td>Pulse</td>
<td>Chip</td>
<td>W3006</td>
<td>3.2dBi</td>
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<tr>
<td>10</td>
<td>TDK</td>
<td>Chip</td>
<td>ANT016008</td>
<td>2.4dBi</td>
</tr>
</tbody>
</table>

The following harmonized standards and technical specifications have been applied:

EN 301489-1 V2.1.1 ElectroMagnetic Compatibility (EMC) standard for radio equipment and services; Part 1: Common technical requirements; Harmonised Standard covering the essential requirements of article 3.1(b) of the Directive 2014/53/EU and the essential requirements of article 6 of the Directive
2014/30/EU:

<table>
<thead>
<tr>
<th>Standard code</th>
<th>Description</th>
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<tbody>
<tr>
<td>EN 301489-17 V3.1.1</td>
<td>ElectroMagnetic Compatibility (EMC) standard for radio equipment and services; Part 17: Specific conditions for Broadband Data Transmission Systems; Harmonised Standard covering the essential requirements of article 3.1(b) of Directive 2014/53/EU</td>
</tr>
<tr>
<td>EN 300328 v2.1.1</td>
<td>Wideband transmission systems; Data transmission equipment operating in the 2,4 GHz ISM band and using wide band modulation techniques; Harmonised Standard covering the essential requirements of article 3.2 of Directive 2014/53/EU</td>
</tr>
<tr>
<td>EN 62311:2008</td>
<td>Assessment of electronic and electrical equipment related to human exposure restrictions for electromagnetic fields (0 Hz - 300 GHz)</td>
</tr>
<tr>
<td>EN 50581:2012</td>
<td>Technical documentation for the assessment of electrical and electronic products with respect to the restrictions of hazardous substances</td>
</tr>
</tbody>
</table>

Notified Body:

<table>
<thead>
<tr>
<th>Notified Body</th>
<th>CTC advanced</th>
</tr>
</thead>
<tbody>
<tr>
<td>Notified Body Number</td>
<td>0682</td>
</tr>
<tr>
<td>Reference number of the certificate of notified body</td>
<td>T818163E-01-TEC</td>
</tr>
</tbody>
</table>

Technical Compliance File Held by:
Texas Instruments Incorporated
12500 TI Boulevard
Dallas, Texas 75243 USA

Signed for and on behalf of Texas Instruments Incorporated

Name: Mattias Lange, General Manager
Address: 12500 TI Boulevard, Dallas, Texas, 75243

Place of issue: 8/30/17
Date of issue: 8/30/17
Signature of Authorized Person
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